

N-CHANNEL SILICON POWER MOSFET

F-II SERIES

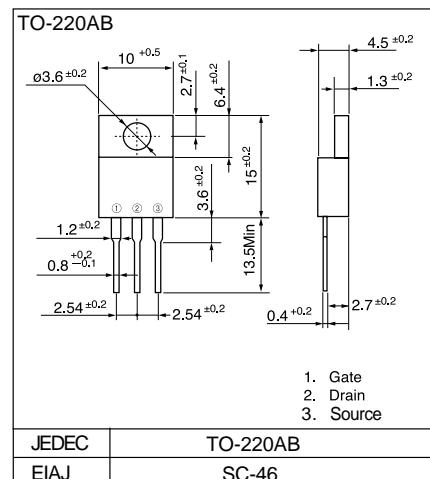
■ Features

- High current
- Low on-resistance
- No secondary breakdown
- Low driving power
- High voltage
- $V_{GSS} = \pm 30V$ Guarantee

■ Applications

- Switching regulators
- UPS
- DC-DC converters
- General purpose power amplifier

■ Outline Drawings

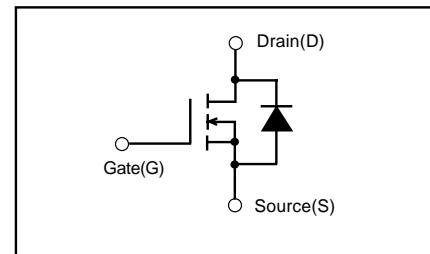


■ Maximum ratings and characteristics

● Absolute maximum ratings (T_c=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Drain-source voltage	V _{DS}	250	V
Continuous drain current	I _D	10	A
Pulsed drain current	I _{D(puls)}	28	A
Continuous reverse drain current	I _{DR}	10	A
Gate-source peak voltage	V _{GSS}	±30	V
Max. power dissipation	P _D	80	W
Operating and storage temperature range	T _{ch}	+150	°C
	T _{stg}	-55 to +150	°C

■ Equivalent circuit schematic

● Electrical characteristics (T_c=25°C unless otherwise specified)

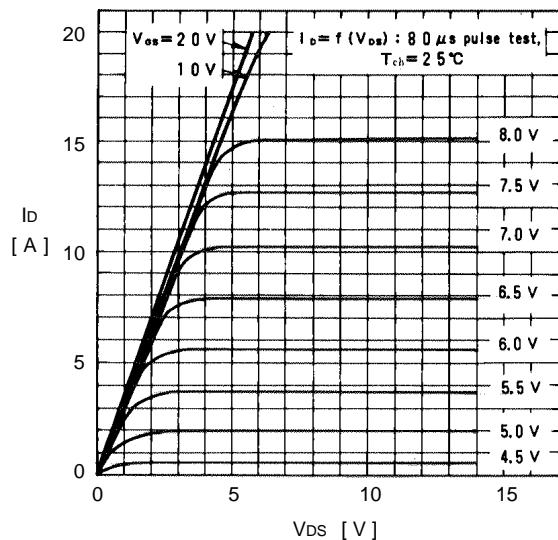
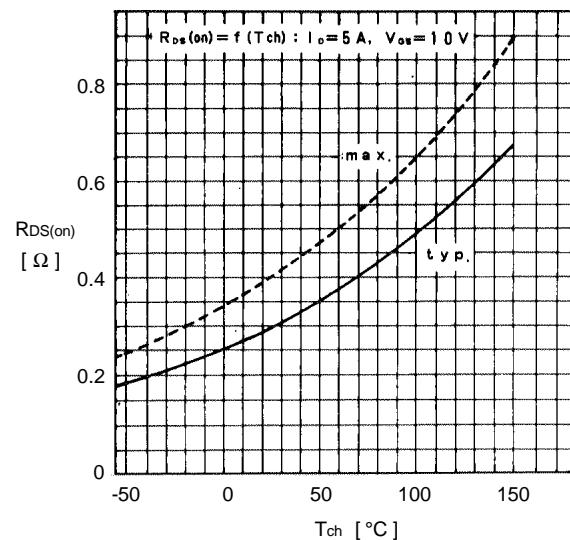
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V _{(BR)DSS}	I _D =1mA V _{GSS} =0V	250			V
Gate threshold voltage	V _{GSS(th)}	I _D =1mA V _{DS} =V _{GSS}	2.5	3.5	5.0	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =250V V _{GSS} =0V	10	500	500	μA
		T _{ch} =25°C	0.2	1.0	1.0	mA
Gate-source leakage current	I _{GSS}	V _{GSS} =±30V V _{DS} =0V	10	100	100	nA
Drain-source on-state resistance	R _{DS(on)}	I _D =5.0A V _{GSS} =10V	0.3	0.4	0.4	Ω
Forward transconductance	g _{fs}	I _D =5.0A V _{DS} =25V	2.0	4.5		S
Input capacitance	C _{iss}	V _{DS} =25V	570	860		pF
Output capacitance	C _{oss}	V _{GSS} =0V	140	210		
Reverse transfer capacitance	C _{rss}	f=1MHz	70	110		
Turn-on time t _{on}	t _{d(on)}	V _{CC} =150V R _G =25Ω	20	30		ns
(t _{on} =t _{d(on)} +t _r)	t _r	I _D =10A	40	60		
Turn-off time t _{off}	t _{d(off)}	V _{GSS} =10V	100	150		
(t _{off} =t _{d(off)} +t _f)	t _f		50	75		
Diode forward on-voltage	V _{SD}	I _F =2xI _{DR} V _{GSS} =0V T _{ch} =25°C	1.12	1.68	1.68	V
Reverse recovery time	t _{rr}	I _F =I _{DR} di/dt=100A/μs T _{ch} =25°C	140			ns

● Thermal characteristics

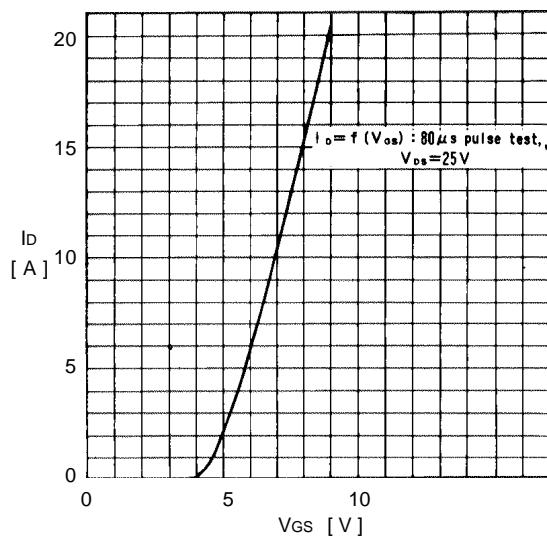
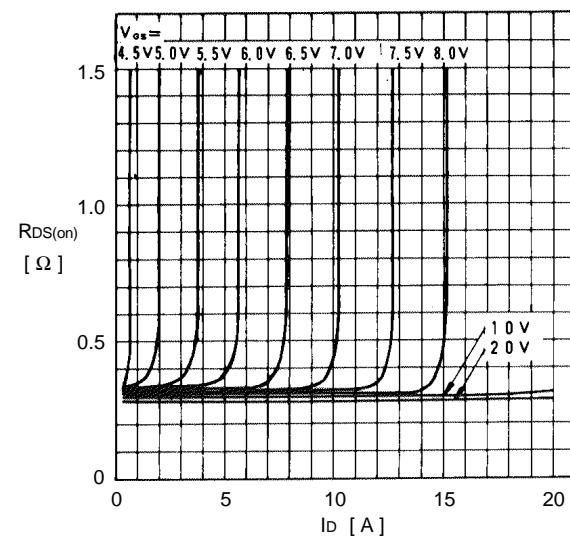
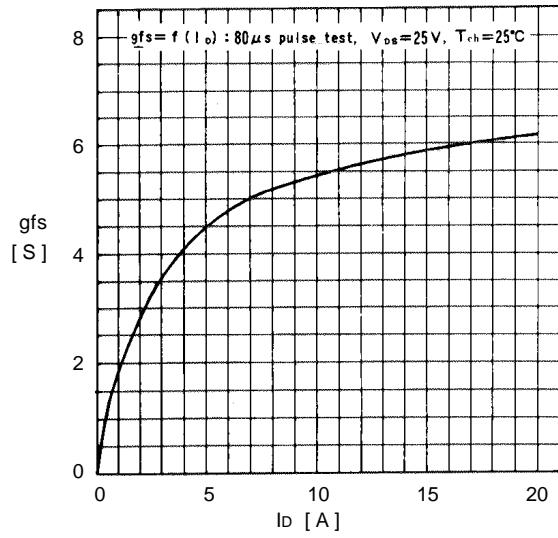
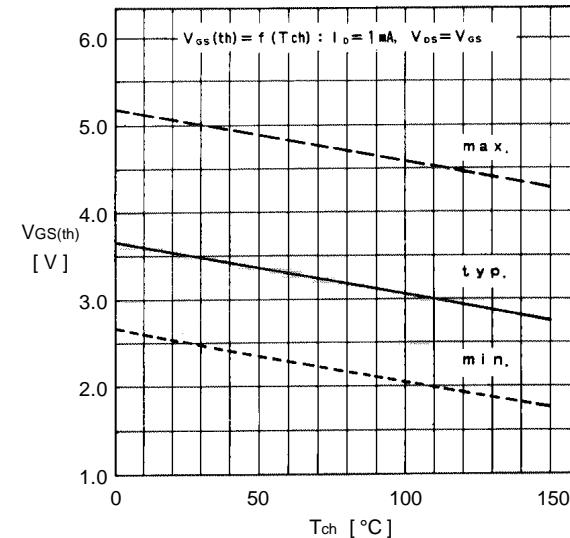
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	R _{th(ch-a)}	channel to ambient			75.0	°C/W
	R _{th(ch-c)}	channel to case			1.56	°C/W

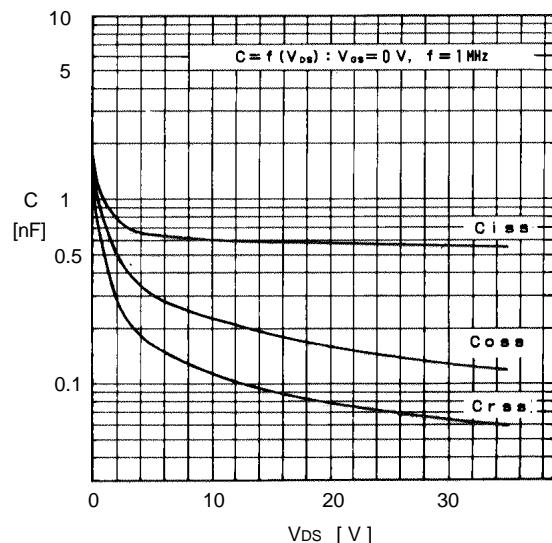
■ Characteristics

Typical output characteristics

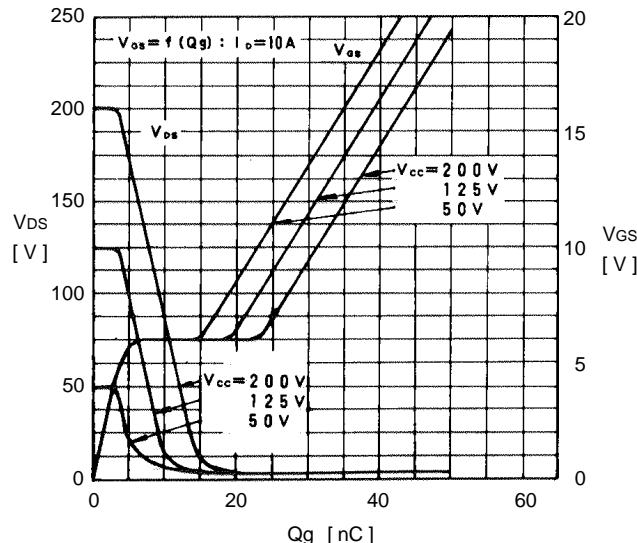
On state resistance vs. T_{ch} 

Typical transfer characteristics

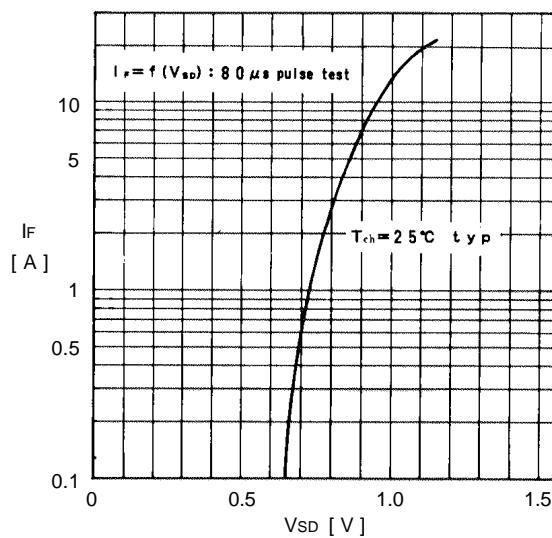
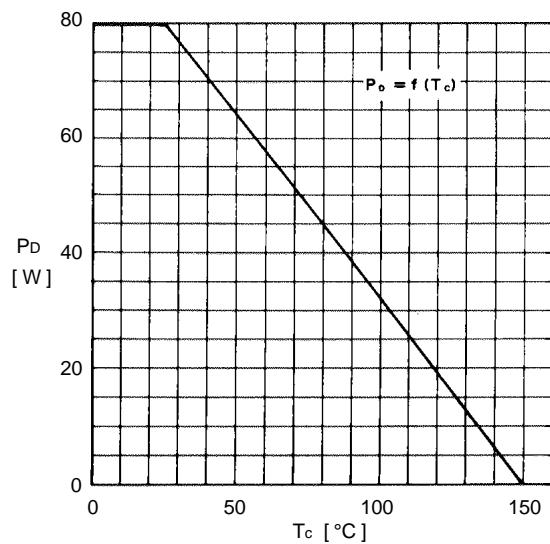
Typical Drain-Source on state resistance vs. I_d Typical forward transconductance vs. I_d Gate threshold voltage vs. T_{ch} 

Typical capacitance vs. V_{DS} 

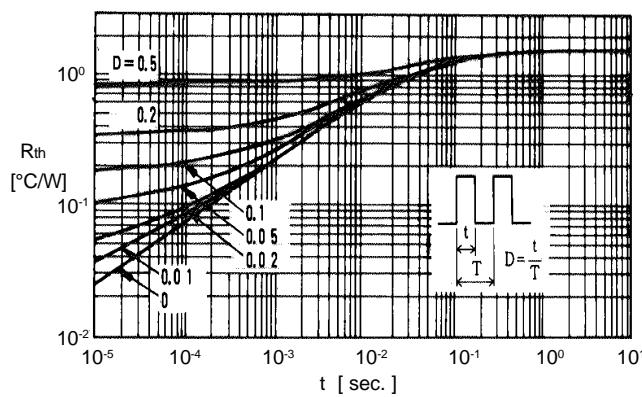
Typical input charge



Forward characteristics of reverse diode

Allowable power dissipation vs. T_c 

Transient thermal impedance



Safe operating area

